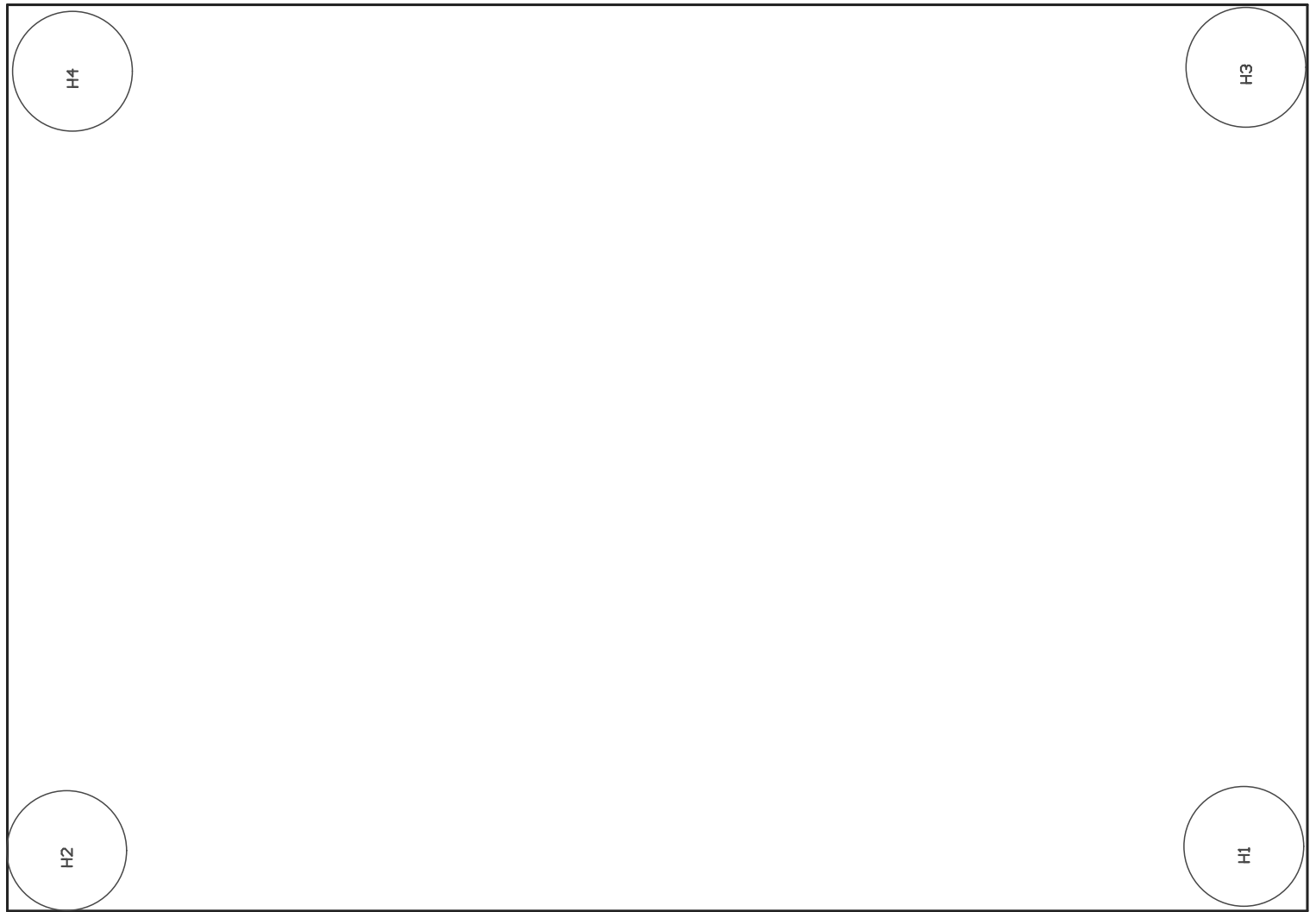


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: 001

|                                  |                                    |                   |                                |
|----------------------------------|------------------------------------|-------------------|--------------------------------|
| PCB VIEWED FROM TOP SIDE         | BOARD #: 001                       | REV: E1           | SUN REV: Not In VersionControl |
| IGNORE ->                        |                                    |                   |                                |
| PLOT NAME = Top Assembly Drawing | GENERATED : 10/29/2015 12:14:45 PM | TEXAS INSTRUMENTS |                                |



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: 001

|                                     |                                    |         |                                |
|-------------------------------------|------------------------------------|---------|--------------------------------|
| PCB VIEWED FROM BOTTOM SIDE         | BOARD #: 001                       | REV: E1 | SUN REV: Not In VersionControl |
| IGNORE ->                           |                                    |         |                                |
| PLOT NAME = Bottom Assembly Drawing | GENERATED : 10/29/2015 12:14:45 PM |         | TEXAS INSTRUMENTS              |

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